January 2001



Si4480DY

80V N-Channel PowerTrench[®] MOSFET

General Description

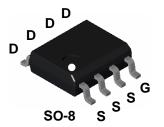
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

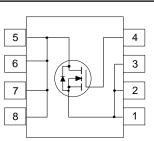
These MOSFETs feature faster switching and lower gate charge than other MOSFETs with comparable $R_{_{\text{DS(ON)}}}$ specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

Features

- 7.6 A, 80 V. $R_{DS(ON)} = 0.029 \ \Omega \ @ V_{GS} = 10 \ V$ $R_{DS(ON)} = 0.033 \ \Omega \ @ V_{GS} = 6 \ V.$
- Low gate charge (34nC typical).
- Fast switching speed.
- High performance trench technology for extremely low $\rm R_{\rm DS(ON)}.$
- High power and current handling capability.





Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		80	V
V _{GSS}	Gate-Source Voltage		<u>+</u> 20	V
I _D	Drain Current - Continuous	(Note 1a)	7.6	А
	- Pulsed		50	
PD	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1	
T _J , T _{stg}	Operating and Storage Junction Temperature Range		-55 to +150	۰C

Thermal Characteristics

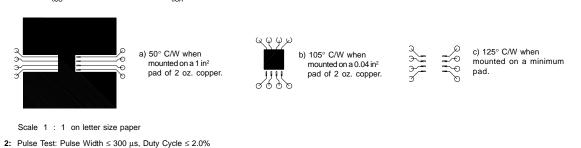
R _{θJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
R _θ JC	Thermal Resistance, Junction-to-Case	(Note 1)	25	∘C/W

Package Outlines and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
4480	Si4480DY	13"	12mm	2500 units

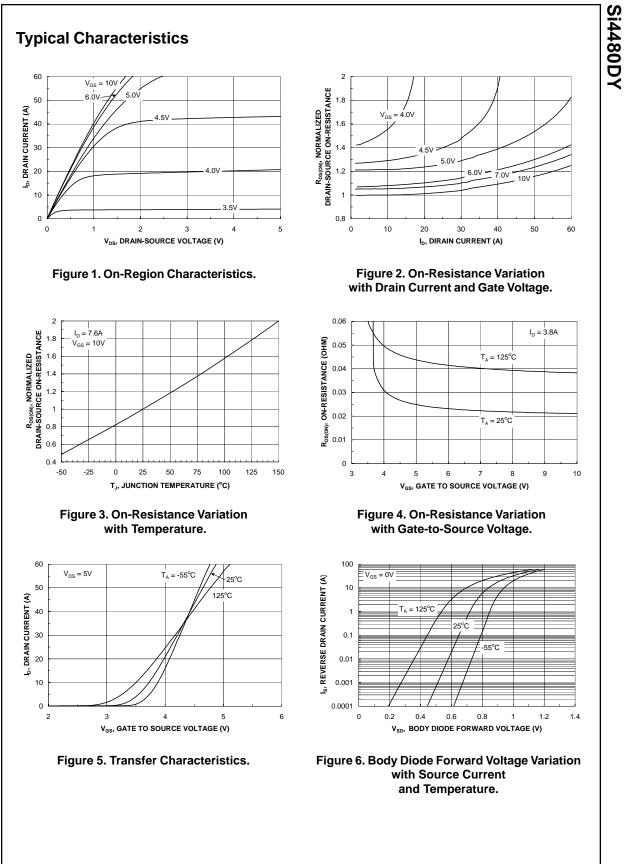
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	urce Avalanche Ratings (Note 2		ļ			
W _{DSS}	Single Pulse Drain-Source Avalanche Energy	V _{DD} = 40 V, I _D = 7.6 A			245	mJ
I _{AR}	Maximum Drain-Source Avalanche C	Current			7.6	А
Off Char	acteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	80			V
ΔBV_{DSS} ΔT_{\perp}	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		81		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 64 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	V_{GS} = -20 V, V_{DS} = 0 V			-100	nA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	2	2.5	4	V
$\Delta V_{GS(th)}$ ΔT_{\perp}	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$		-7		mV/°C
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = 10 V, I_D = 7.6 A$ $V_{GS} = 10 V, I_D = 7.6 A, T_J = 125^{\circ}C$ $V_{GS} = 6 V, I_D = 7 A$		0.022 0.037 0.024	0.029 0.055 0.033	Ω
I _{D(on)}	On-State Drain Current	$V_{GS} = 10 \text{ V}, \text{ V}_{DS} = 5 \text{ V}$	30			Α
g _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 7.6 A$		28		S
Dvnamic	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		1800		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		180		pF
C _{rss}	Reverse Transfer Capacitance			90		pF
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 40 V, I_D = 1 A,$		13	26	ns
t _r	Turn-On Rise Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		8	20	ns
t _{d(off)}	Turn-Off Delay Time	1		34	60	ns
t _f	Turn-Off Fall Time	1		16	30	ns
Qg	Total Gate Charge	$V_{DS} = 40 V, I_D = 7.6 A,$		34	46	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		6.1		nC
Q _{gd}	Gate-Drain Charge			6.9		nC
Drain-So	urce Diode Characteristics a	nd Maximum Ratings				
l _s	Maximum Continuous Drain-Source I	-			2.1	Α
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)	1	0.74	1.2	V

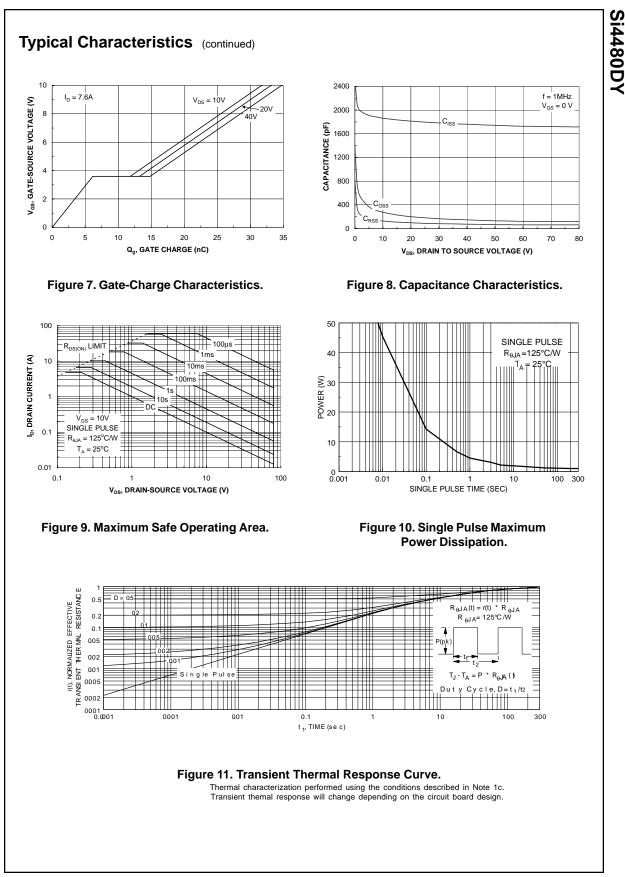
1: $R_{\theta,JA}$ is the sum of the junction-to-case and case-to-ambient resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta,JC}$ is guaranteed by design while $R_{\theta,CA}$ is determined by the user's board design.



Si4480DY Rev A

Si4480DY





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